# UM11516

## Component Library – Sensor Drivers Component

Rev. 1 — 2 November 2020 User manual

**Document information**

| Information | Content |
|---|---|
| Keywords | Component Library, Sensor Drivers |
| Abstract | Getting started with sensor drivers component |

## Revision history

| Rev | Date | Description |
|---|---|---|
| 1 | 20201102 | Initial release |

# 1 Prerequisites

This document assumes following prerequisites prior to attempting use of this platform agnostic component library – sensor drivers:

- Only basic software development knowledge is needed when using the example application (provided in this component library package) with the same hardware used in the example application.
- The user is familiar with the chosen microcontroller unit (MCU), corresponding software development kit (SDK) and cross-compilation tool chain to integrate sensor driver component.
- The user is familiar with the MCU SDK implementation for underlying microcontroller peripherals such as $I^2C$, SPI, etc., in order to integrate with the sensor driver component.

# 2 Overview

The sensor drivers component is a development model that provides sensor driver development rules for specific sensors manufactured by NXP with platform independent interfaces. The platform interface provides abstraction to the underlying communication driver in SDK, tool chains and MCUs.

## 2.1 Sensor driver component design

The sensor driver is an abstraction of the sensor driver interface, which has specific communication interfaces defined. It provides users the flexibility of drop the files in from sources and includes or from the library into the user application space. It could run as a standalone application in the application space or run in a multi-threaded environment. In the multi-threaded environment, the user application is responsible for handling the multi-threading synchronization and resource handling. It is designed to work seamlessly in any SDK environment and application resource handlers.

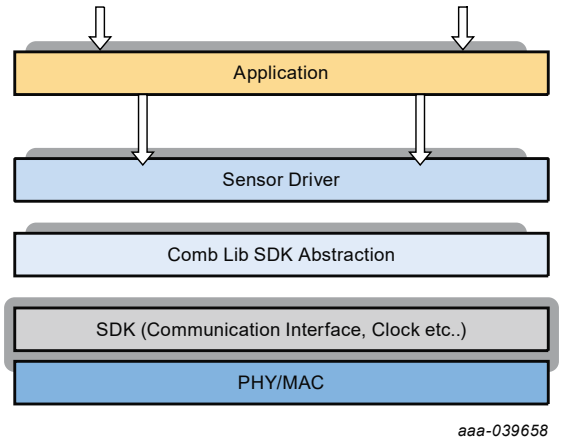


**Figure 1. Sensor driver component design**

# 3 Sensor driver component integration for non-example SDKs

The sensor driver models are microcontroller agnostic. This section describes development steps to integrate sensor drivers into any microcontroller software development kit (SDK). The sensor driver interfaces are generic for all sensor operations by using the common sensor communication virtual interface. The virtual interfaces (sensor_comm.c and sensor_comm.h) need to be implemented by the user of sensor driver component for underlying microcontroller SDK communication interfaces similar to $I^2C$, and SPI, for example. The implementation could be just the integration of underlying SDK drivers ($I^2C$, SPI) to the common interface. The example application included in this sensor component package provides the reference for the integration.

## 3.1 Sensor driver component directory structure

This section provides a snapshot of the sensor driver component directory structure. The below provided snapshot shows directory structure for the sensor drivers component.

```
sensor_driver/
|-- <src>common
|   |-- sensor_comm.c
|   |-- sensor_comm.h
|   |-- sensor_common.c
|   `-- sensor_common.h
|-- <src><sensor>
|   |-- <sensor>_config.c
|   |-- <sensor>_config.h
|   |-- <sensor>_driver.c
|   |-- <sensor>_driver.h
|   `-- <sensor>_regdef.h
|-- examples
|   |---|MCUXpresso
|   |   |   └── <project_name>
`-- docs
|   |-- Sensor_Drivers_API_Reference_Manual.zip
```

Where `<sensor>` is used as a common nomenclature of supported sensors, for example, fxos8700, fxls8471q, mma865x and fxls8962, etc.

The sensor driver implementations and interface definitions for a `<sensor>` (e.g. fxls8471, fxos8700, MMA865x and FXLS8962) are available under their respective sensor folder (for more details on sensor driver file descriptions, please refer to Section 3.2 ). The sensor driver interface definitions use common sensor communication interfaces provided as template functions under the common folder. End users should update the common sensor communication function template using the SDK implementation for underlying microcontroller peripherals such as $I^2C$, SPI. The sensor drivers have undergone limit testing for NXP microcontrollers FRDM-K64F, FRDM-K22F (Arm Cortex M4F core) and FRDM-KL25Z (Arm Cortex M0+ core) using MCUXpresso SDK implementation for underlying NXP microcontroller peripherals. The reference example project for testing sensor driver integration with MCUXpresso SDK is available under the “examples” folder.

## 3.2 Sensor driver component content overview

This section provides a brief overview of the sensor driver source file contents and file descriptions:

```
sensor_drivers/
|--<src> common     <Folder containing common sensor
 communication interfaces>
|   |-- sensor_comm.c       <Files containing common sensor
 communication interfaces template>
|   |-- sensor_comm.h
|   |-- sensor_common.c     <Files containing common sensor
 communication definitions>
|   `-- sensor_common.h
|
|-- <src>   <Folder containing driver implementation for
 <sensor>>
|   |-- <sensor>_config.c   <File containing register config
 definitions for <sensor>>
|   |-- <sensor>_config.h
|   |-- <sensor>_driver.c   <File containing driver interface
 definitions for <sensor>>
|   |-- <sensor>_driver.h
|   `-- <sensor>_regdef.h   <File containing register
 definitions & bit-map for <sensor>>
|-- example   <Folder containing <sensor> driver integration
 example with MCUXpresso SDK>
|   |   |-- MCUXpresso[1]
|   |   |   └── <project_name>

`-- doc   <Folder containing release documentation for sensor
 driver component>
|   |-- Sensor_Drivers_API_Reference_Manual.zip <Sensor Drivers
 Component API RM >
```

***Note:*** *The standalone MCUXpresso IDE supported example applications demonstrating integration of component libraries for underlying microcontroller MCUXpresso SDK requires corresponding microcontroller SDK package to be downloaded and installed on MCUXpresso IDE before importing the component library example project.*

## 3.3 Sensor driver component integration steps for any MCU and SDK

This section provides steps to be followed to start development/porting of <sensor> drivers on chosen microcontroller platform and integrating with corresponding SDK implementation for microcontroller peripherals.

1. Identify sensor use case and choose appropriate <sensor> driver component and source files from the component folder to start development on any host microcontroller unit (MCU) using corresponding MCU SDK and required cross-compilation tool chain. The source files provided for each component are platform agnostic and can be directly used in any MCU and SDK. There might be some tool chain specific adjustments that need to be done in the source files according to chosen tool chain.

1 Components libraries are provided with NXP's MCUXpresso SDK integration example application. The integration test example applications demonstrate how to integrate platform agnostic component libraries with underlying microcontroller SDK communication interfaces using virtual interface abstraction provided by component libraries.

Note: The sensor driver component covers sensor drivers supporting register configurations needed for data read modes and embedded functions described in respective data sheet. In case the use case requires additional sensor configuration, then update <sensor>_config.c/.h.

2. Use the sensor driver component SDK abstraction functions defined in sensor_comm.c and .h to update SDK implementation for underlying host MCU peripherals like $I^2C$, SPI
3. Refer to the example application structure for the similar implementations
4. Cross-compile the project (resolve compilation & linking errors) and use tool chain debugger to load the generated binary to target MCU. Use UART debug console to verify output.

# 4 Creating a sensor data read example

This section provides a typical flow of creating a sensor data read example using sensor driver models for any host MCU.

Figure 2 describes typical code flow for a sensor data read (in polling mode) example that can be created using sensor driver models.

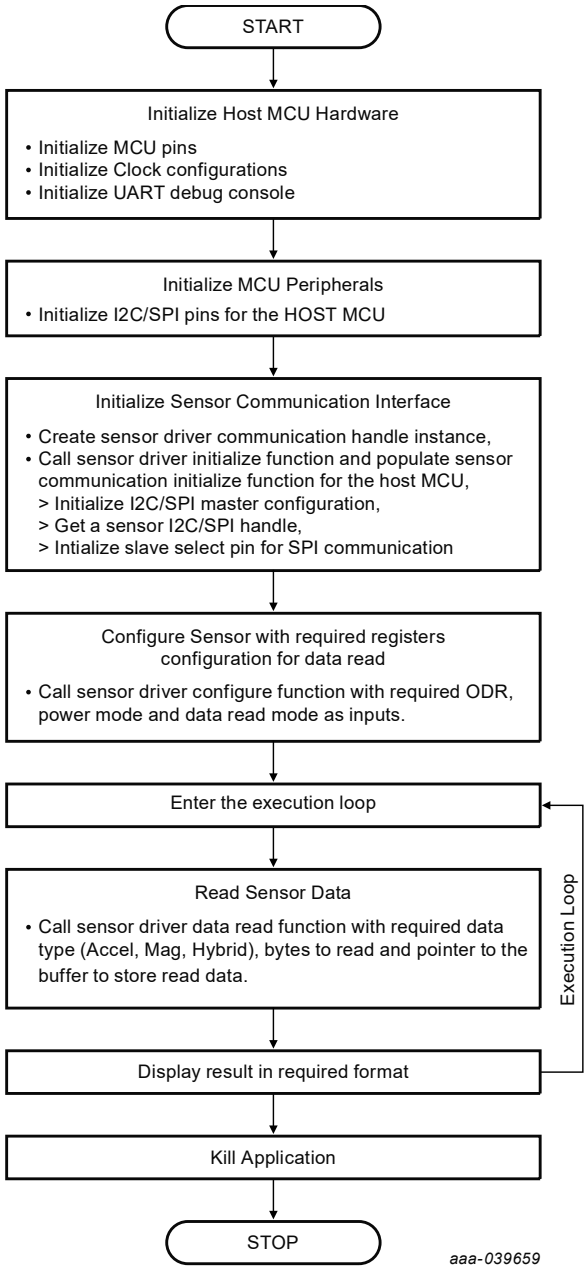


**Figure 2. Typical code flow for a sensor data read (polling mode) example**

Figure 3 describes typical code flow for a sensor data read (in interrupt mode) example that can be created using sensor driver models.

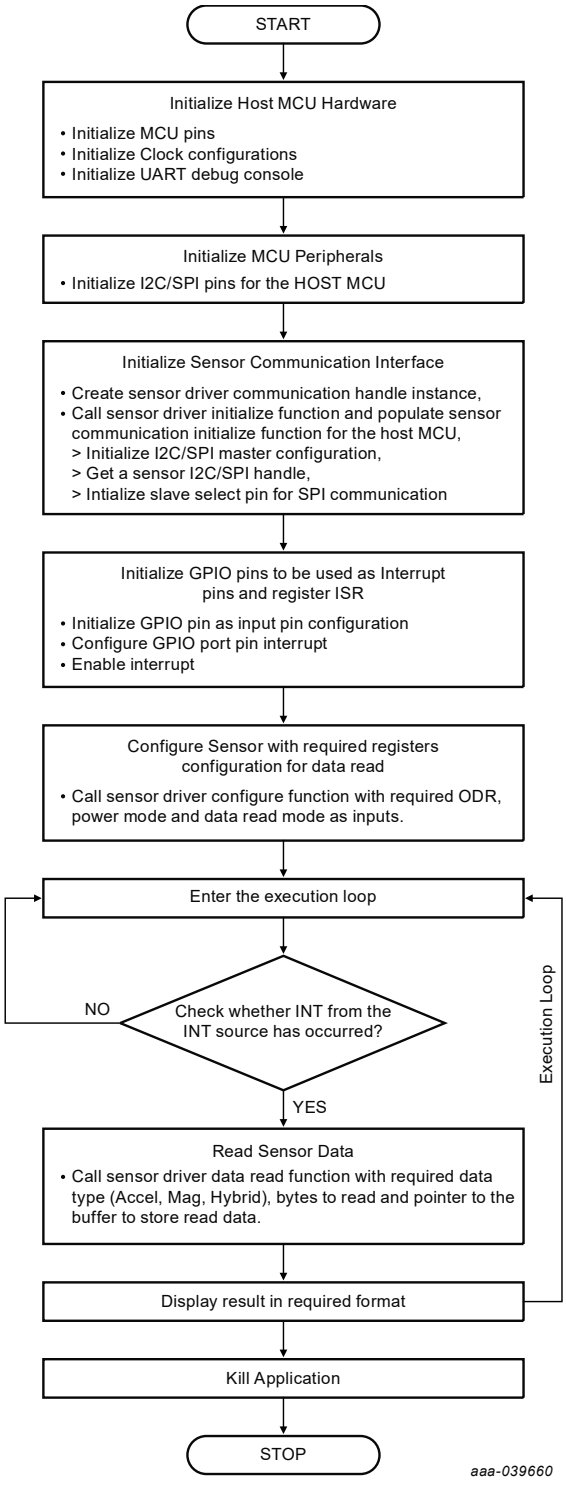


**Figure 3. Typical code flow for a sensor data read (interrupt mode) example**

# 5 Creating a sensor embedded function event read example

This section provides a typical flow of creating a sensor event read example using sensor driver models supporting embedded functions for any host MCU.

Figure 4 describes typical code flow for a sensor event read example that can be created using sensor driver models.

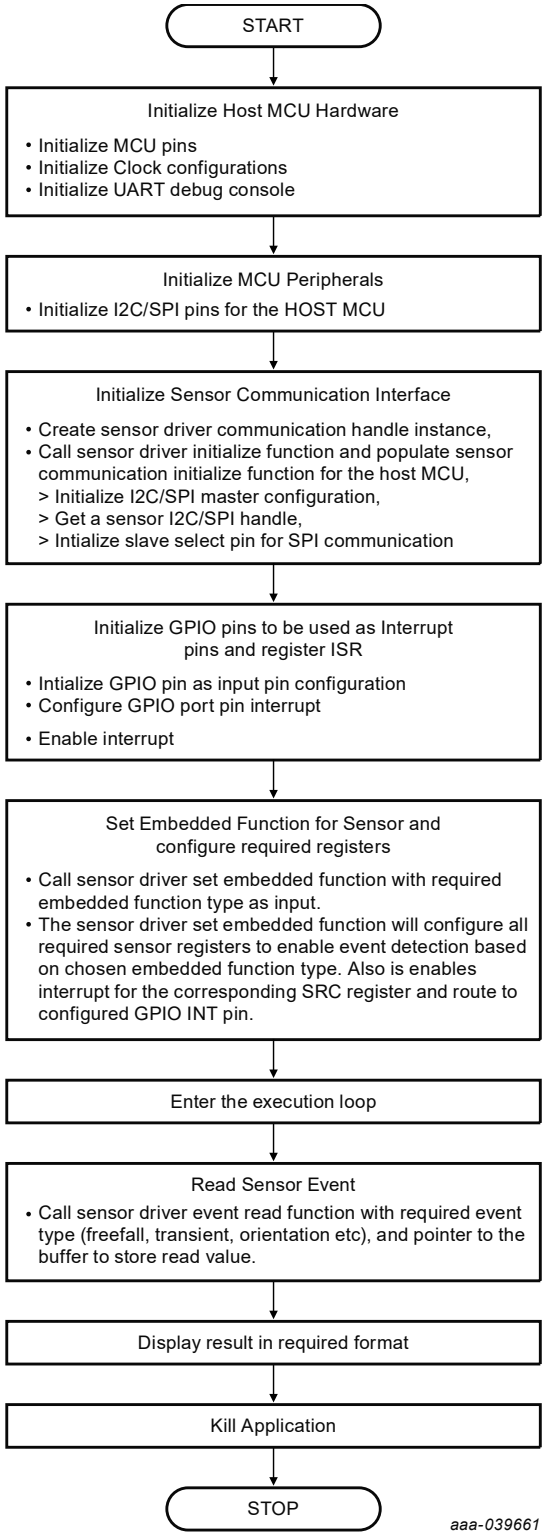


**Figure 4. Typical code flow for a sensor embedded function event read example**

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# Figures

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**Date of release: 2 November 2020**
**Document identifier: UM11516**